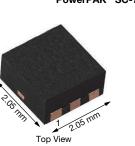
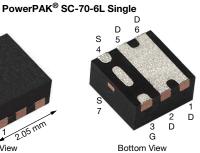
SiA415DJ

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Marking code: BG

PRODUCT SUMMARY				
V _{DS} (V)	-20			
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.035			
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.051			
Q _g typ. (nC)	15			
I _D (A) ^a	-12			
Configuration	Single			

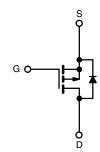
FEATURES

P-Channel 20-V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- New thermally enhanced PowerPAK[®] SC-70 package
 - Small footprint area
 - Low on-resistance
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

· Load switch, PA switch and battery switch for portable devices



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SC-70-6L
Lead (Pb)-free and halogen-free	SiA415DJ-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unless	otherwise note	d)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-20	v	
Gate-source voltage		V _{GS}	± 12	v	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-12 ^a		
	T _C = 70 °C		-12 ^a	-	
	T _A = 25 °C	I _D	-8.4 ^{b, c}	-	
	T _A = 70 °C		-6.7 ^{b, c}	А	
Pulsed drain current		I _{DM}	-30	7	
Continuous source-drain diode current	T _C = 25 °C		-12 ^a	-	
	T _A = 25 °C	I _S	-2.9 ^{b, c}	-	
Maximum power dissipation	T _C = 25 °C		19		
	T _C = 70 °C		12	14/	
	T _A = 25 °C	P _D —	3.5 ^{b, c}	W	
	T _A = 70 °C		2.2 ^{b, c}	1	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260	-0	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	5.3	6.5	0/10	

Notes

a. Package limited b. Surface mounted on 1" x 1" FR4 board

t = 5 s c.

See solder profile (<u>www.vishav.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components d.

e.

Maximum under steady state conditions is 80 °C/W f.

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RoHS COMPLIANT HALOGEN FREE

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Static	•			•	•	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$	L 050A	-	-20	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	3.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.6	-	-1.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	± 100	nA	
Zene ende velke en elveire enveret		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	uА	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	-20	-	-	A	
		V _{GS} = -4.5 V, I _D = -5.6 A	-	0.029	0.035		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -2.5 V, I _D = -2 A	-	0.042	0.051	Ω	
Forward transconductance a	g _{fs}	V _{DS} = -10 V, I _D = -5.6 A	-	20	-	S	
Dynamic ^b				I	•	I	
Input capacitance	C _{iss}		-	1250	-	pF	
Output capacitance	C _{oss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	-	250	-		
Reverse transfer capacitance	C _{rss}		- 190		-	- ·	
-		V _{DS} = -10 V, V _{GS} = -10 V, I _D = -8.4 A	-	31	47		
Total gate charge	Qg		-	15	23	nC	
Gate-source charge	Q _{qs}	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -8.4 \text{ A}$	-	2.8	-		
Gate-drain charge	Q _{gd}		-	5	-		
Gate resistance	R _q	f = 1 MHz	-	7	-	Ω	
Turn-on delay time	t _{d(on)}		-	25	40	-	
Rise time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	50	75		
Turn-off delay time	t _{d(off)}	$I_D \cong$ -6.7 Å, V_{GEN} = -4.5 V, R_g = 1 Ω	-	40	60		
Fall time	t _f		-	20	30		
Turn-on delay time	t _{d(on)}		-	10	15	ns	
Rise time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	10	15	-	
Turn-off delay time	t _{d(off)}	$I_D \cong -6.7 \text{ A}, V_{GEN} = -10 \text{ V}, \text{ R}_g = 1 \Omega$	-	45	70		
Fall time	t _f		-	12	20		
Drain-Source Body Diode Characteris	lics				•		
Continuous source-drain diode current	IS	T _C = 25 °C	-	-	-12	_	
Pulse diode forward current	I _{SM}		-	-	30	A	
Body diode voltage	V _{SD}	I _S = -6.7 A, V _{GS} = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	35	55	ns	
Body diode reverse recovery charge	Q _{rr}		-	21	35	nC	
Reverse recovery fall time	t _a	$I_F = -6.7 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 ^\circ\text{C}$	-	12	-		
Reverse recovery rise time	t _b		-	23	-	ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



2.0

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 $T_{\rm C} = -55$

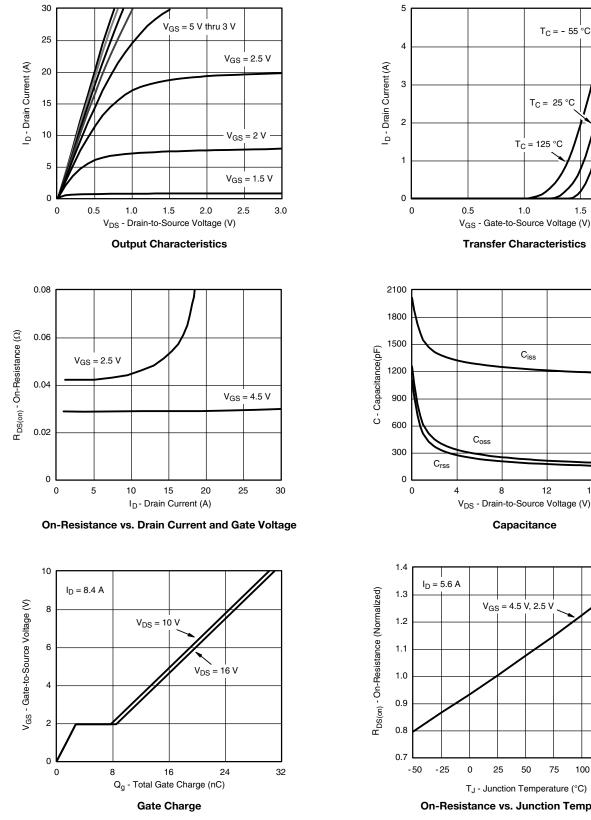
 $T_C = 25 °C$

1.5

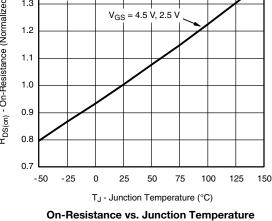
T_C = 125 °C

1.0

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Ciss Coss 8 12 16 20 V_{DS} - Drain-to-Source Voltage (V) Capacitance



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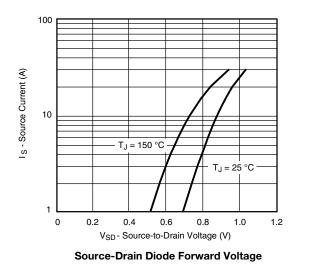
3 For technical questions, contact: pmostechsupport@vishay.com Document Number: 69512

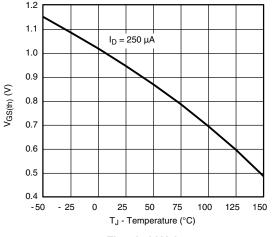
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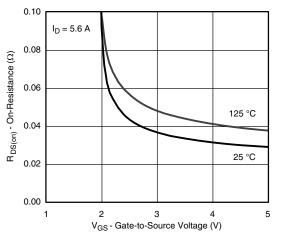
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

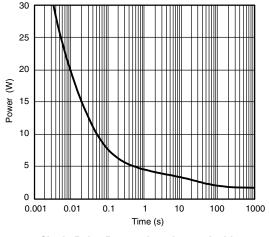




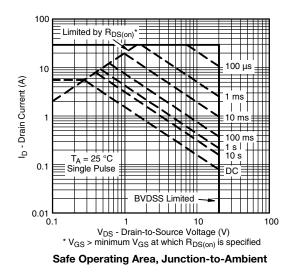
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



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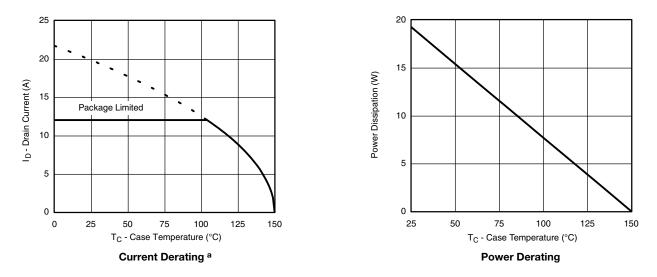
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



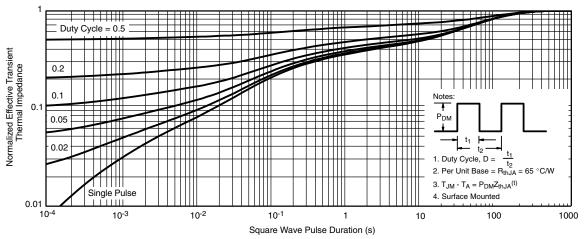
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

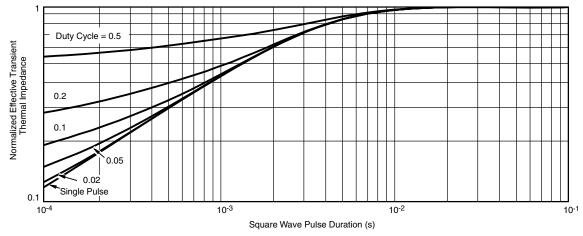


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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